

<b>Notice of References Cited</b>		Application/Control No.	Applicant(s)/Patent Under Reexamination PETERSON ET AL.
		09/955,722 Examiner Eugene Lee	
<b>U.S. PATENT DOCUMENTS</b>			

*	Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
A	US-4,691,225	09-1987	Murakami et al.	257/693
B	US-5,291,062	03-1994	Higgins, III, Leo M.	257/698
C	US-			
D	US-			
E	US-			
F	US-			
G	US-			
H	US-			
I	US-			
J	US-			
K	US-			
L	US-			
M	US-			

**FOREIGN PATENT DOCUMENTS**

*	Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
N					
O					
P					
Q					
R					
S					
T					

**NON-PATENT DOCUMENTS**

*	Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages
U	C-Shield Parylene allows major weight saving for EM shielding of microelectronics, Jan Noordgraaf et al. IEEE 1997.
V	Internal Conformal Coating for Microcircuits, Whittington et al. IEEE 1978.
W	Hermetic Plastic packages with Applications to Ruggedized Boards, Val et al. IEEE 1991.
X	Alkyltrichlorosilane-Based Self Assembled Monolayer Films for Stiction Reduction in Silicon Micromachines, Srinivasan et al. IEEE 1998.

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.